TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSVI)

2SK3568

Switching Regulator Applications

Low drain-source ON resistance: RDS (ON) = 0.4Ω (typ.)

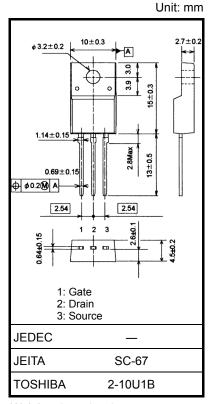
• High forward transfer admittance: $|Y_{fs}| = 8.5S$ (typ.)

• Low leakage current: $I_{DSS} = 100 \, \mu \, A \, (V_{DS} = 500 \, V)$

• Enhancement mode: $V_{th} = 2.0 \sim 4.0 \text{ V} \text{ (V}_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA)}$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	500	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	500	V	
Gate-source voltage		V_{GSS}	±30	V	
Drain current	DC (Note 1)	I _D	12		
	Pulse (t = 1 ms) (Note 1)	I _{DP}	48	Α	
Drain power dissipation (Tc = 25°C)		P _D	40	W	
Single pulse avalanche energy (Note 2)		E _{AS}	364	mJ	
Avalanche current		I _{AR}	12	Α	
Repetitive avalanche energy (Note 3)		E _{AR}	4	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

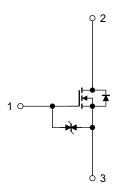
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.125	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{Ch} = 25°C(initial), L = 4.3 mH, I_{AR} = 12 A, R_G = 25 Ω

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



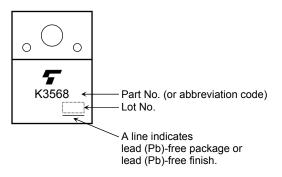
Electrical Characteristics (Ta = 25°C)

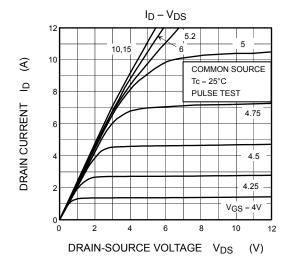
Char	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rent	I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Gate-source brea	akdown voltage	V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V
Drain cut-off curr	ent	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	_	_	100	μА
Drain-source bre	akdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	500	_		٧
Gate threshold v	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	٧
Drain-source ON	resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 6 A	_	0.4	0.52	Ω
Forward transfer	admittance	Yfs	V _{DS} = 10 V, I _D = 6 A	3.5	8.5	_	S
Input capacitance		C _{iss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	1500	_	pF
Reverse transfer capacitance		C _{rss}		_	15	_	
Output capacitance		Coss		_	180	_	
Switching time	Rise time	t _r	$\begin{array}{c c} 10 \text{ V} & \text{ID} = 6 \text{ A} & \text{Vout} \\ \hline VGS & \\ 0 \text{ V} & \\ \hline 50 \Omega & \\ \end{array} \begin{array}{c} \text{ID} = 6 \text{ A} & \text{Vout} \\ \end{array} \begin{array}{c} \text{RL} = \\ 33 \Omega \\ \end{array}$ $\text{VDD} \approx 200 \text{ V}$	_	22	_	
	Turn-on time	t _{on}		_	50	_	no
	Fall time	t _f		_	36	_	ns
	Turn-off time	t _{off}	Duty ≦ 1%, t _W = 10 μs	_	170		
Total gate charge		Qg		_	42	_	
Gate-source charge		Q _{gs}	$V_{DD} \simeq 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$	_	23	_	nC
Gate-drain charge		Q _{gd}		_	19	_	

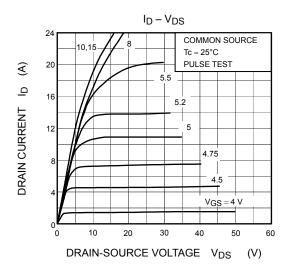
Source-Drain Ratings and Characteristics (Ta = 25°C)

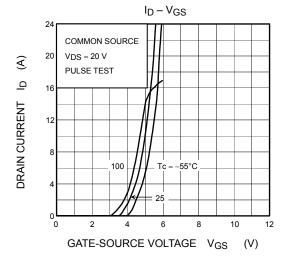
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	12	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	48	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 12 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	$I_{DR} = 12 \text{ A}, V_{GS} = 0 \text{ V},$	_	1200	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 100 A/μs		16		μС

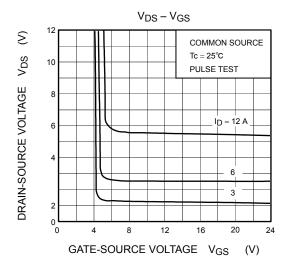
Marking

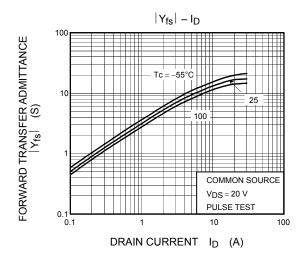


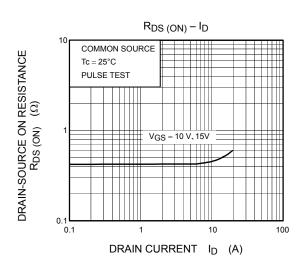




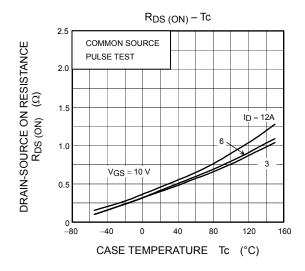


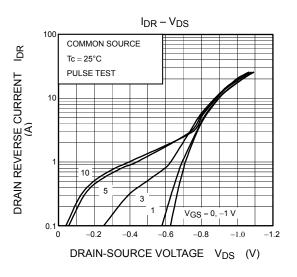


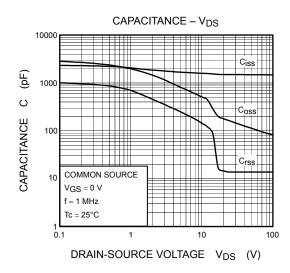


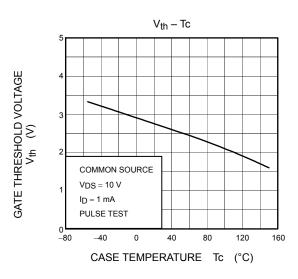


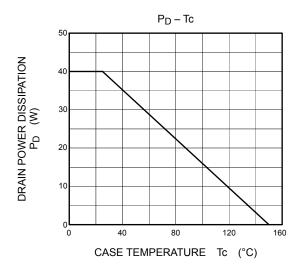
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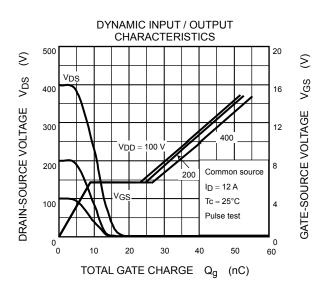


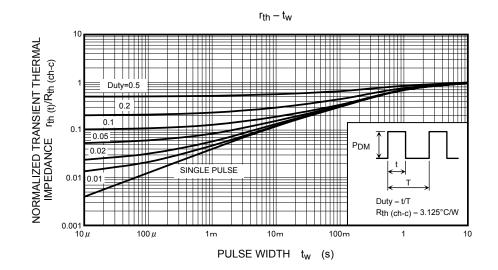


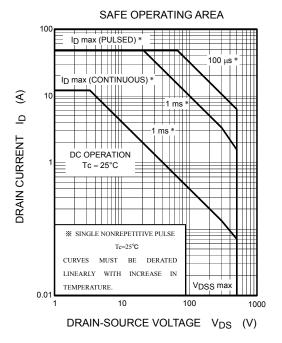


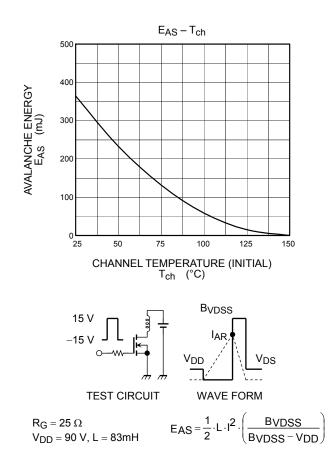












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